



Attly. Dkt. No. AMAT/6228/CMP/ECP/RKK

PATENT

AF
1753
IFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Bajaj, et al.

Serial No.: 10/074,141

Confirmation No.: 6612

Filed: February 11, 2002

For: ADDITIVES FOR
ELECTROPLATING
SOLUTION

Group Art Unit: 1753

Examiner: Edna Wong

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING

37 CFR 1.8

I hereby certify that this correspondence is being deposited on
July 2, 2004 with the United States Postal Service as First
Class Mail in an envelope addressed to: Commissioner for
Patents, P.O. Box 1450, Alexandria, VA 22313-1450

7/2/04
Date

[Signature]
Signature

Dear Sir:

RESPONSE TO FINAL OFFICE ACTION DATED FEBRUARY 3, 2004

In response to the Final Office Action dated February 3, 2004, having a shortened statutory period for response extended two months to July 6, 2004, please enter this response and reconsider the claims pending in the application for reasons discussed below. A petition for a two-month extension of time is also submitted herewith. The Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/6228/BTP, the fee of \$764.00, for a two month extension fee (\$420.00), four (4) additional independent claims (\$344.00), and any other fees, including excess claim fees, required to make this response timely and acceptable to the Office.

New Claims are reflected in the listing of claims which begins on page 2 of this paper. Remarks begin on page 6 of this paper.

07/07/2004 SDIRETR1 00000087 200782 10074141

01 FC:1252 420.00 DA
02 FC:1201 344.00 DA